DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

	EXPANDER			
the specification	of which is attached hereto unl	ess the following is ch	ecked	
was filed on	as United States Applicad on (if applicable).			n Number
	at I have reviewed and understa nded by any amendment referre		above-identified specification,	including the
I acknowledge th Federal Regulation	ne duty to disclose information ons, § 1:56.	which is material to pa	tentability as defined in Title 3	37, Code of
application(s) for patent or invento	oreign priority benefits under T r patent or inventor's certificate r's certificate having a filing de	listed below and have	also identified below any fore	ign application for
(List prior foreign applications. See	2002-303982	Japan	18/October/2002	⊠ Yes □ No
note A below)	(Number)	(Country)	(Day/Month/Year Filed)	
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
				Yes No
(See note B belo	(Number)	(Country)	(Day/Month/Year Filed) rior foreign applications	
I hereby claim to and, insofar as application in the duty to disclose	the benefit under Title 35, Unit the subject matter of each of the manner provided by the first information which is material ame available between the fili	ited States Code, § 12 the claims of this app it paragraph of Title 2 to patentability as de	20 of any United States applic lication is not disclosed in the 35, United States Code, § 112 fined in Title 37, Code of Fe	e prior United States 2, I acknowledge the ederal Regulations, §
(List prior U.S.			Statu	ıs
Applications)	(Application Serial No.)	(Filing Date)	Patented Pend	ling 🔲 Abandoned
-	(Application Serial No.)	(Filing Date)	Patented Pend	ling 🗌 Abandoned
-	(Application Serial No.)	(Filing Date)	Patented Pend	ling Abandoned

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

(See note C)



I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name)		Akira HIWATA	
Inventor's signature	Akira Hiwita	Date August 8, 2003	
Residence	Kyoto, Japan	Citizenship Japanese	
Post Office Address	3-1-107, Koutari Midoro, Nag	aokakyo-shi, Kyoto 617-0833	
	Japan		
Full name of second inventor (given name, family name)		Noboru IIDA	
Inventor's signature	Noboru Iida	Date August 8, 2003	
Residence	Shiga, Japan	Citizenship Japanese	
Post Office Address	6-18-8, Ichiriyama, Otsu-shi,	Shiga 520-2153 Japan	
Full name of third in	ventor (given name, family name)		
Inventor's signature		Date	
Residence		Citizenship	
Post Office Address			
	inventor (given name, family name)		
Inventor's signature		Date	
Residence		Citizenship	
Post Office Address			
			
Full name of fifth in	ventor (given name, family name)		
Inventor's signature		Date	
Residence		Citizenship	
Post Office Address			